AFCT-721XPDZ

10GbE/10GFC 1310 nm XFP 10 Gbit/s Optical Transceiver



Data Sheet



Description

The 1310 nm XFP transceiver is a high performance, cost effective module for serial optical data communications applications specified for signal rates of 10.30 Gb/s to 11.3 Gb/s. It is compliant to XFP MSA Rev 4.5. The module is designed for single mode fiber and operates at a nominal wavelength of 1310 nm. The transmitter section incorporates Avago Technologies' uncooled directly modulated 1310 nm distributed feedback laser (DFB). The receiver section uses Avago Technologies' MOVPE grown planar TEDET PIN photodetector for low dark current and excellent responsivity. Integrated Tx and Rx signal conditioners provide high jitter-tolerance for full XFI compliance. The internally AC coupled high speed serial I/O simplifies interfacing to external circuitry. The electrical interface is made using an industry standard 0.8 mm pitch 30-pin right angle connector. Optical connection is made via the duplex LC connector.

Applications

- Fibre Channel Switches
- Host Bus Adapter Cards
- Mass Storage System and Server I/O
- Ethernet Switches
- Core Routers

Related Products

- AFCT-711XPDZ:Multi-rate1310nmXFP10Gbit/sOptical Transceiver for SONET/SDH OC-192, 10GbE & 10GFC
- AFBR-720XPDZ: 10GbE 850nm XFP 10Gbit/s Optical Transceiver

Features

- RoHS-6 Compliant
- Supports 10.3Gb/s to 11.3Gb/s bit rates
- Compliant to XFP MSA
- Supports 10Gb/s Ethernet and Fibre Channel
 - IEEE 802.3ae 10GBASE-LR for 10GbE, 10.3125 Gb/s
 - 10GFC 1310 nm Serial PMD, type 1200-SM-LL-L, 10.51875 Gb/s
- Avago Technologies' uncooled 1310 nm DFB Laser and PIN Photodiode
- Compliant XFI 10G Serial electrical interface
- LC Duplex optical connector interface conforming to ANSI TIA/EIA604-10 (FOCIS 10)
- 1.5W typical power dissipation
- No Reference Clock required
- Superior Thermal and EMI integrity performance to support high port densities
- Customizable clip-on heatsink to support a variety of line card environments
- -5 to +70 °C case operating temperature range
- Support XFI loopback
- 2-wire serial management interface provides real time monitors of:
 - Transmitted Optical Power
 - Received Optical Power
 - Laser Bias Current
 - Module Temperature
- Link Lengths up to 10 km with 9 μm fiber
- IEC 60825-1 Class 1/CDRH Class 1 laser eye safety.

The product also offers digital diagnostics using the 2-wire serial interface defined in the XFP MSA. The product provides real time temperature (module and laser), supply voltage, laser bias current, laser average output power and received input power. The digital diagnostic interface also adds the ability to disable the transmitter (TX_DIS), power down the module, monitor for module faults and monitor for Receiver Loss of Signal (RX_LOS). Transmitter disable, interrupt, power down/reset, receiver loss of signal and module not ready are also hard wired pins on the 30-pin right angle connector.

Installation

The AFCT-721XPDZ can be installed in any XFP port regardless of host equipment operating status. The AFCT-721XPDZ is hot-pluggable, allowing the module to be installed while the host system is operating and on-line. The clip-on heatsink is designed to clip on to the XFP cage without a module present.

Upon insertion, the transceiver housing makes initial contact with the host board XFP cage, mitigating potential damage due to Electro-Static Discharge (ESD). Once fully inserted into the XFP cage, the top surface of the XFP module makes contact with the heatsink through a cutout in the top of the cage ensuring an effective thermal path for module heat.

Functional Description

Transmitter Section

The transmitter section includes a 1310 nm DFB (Distributed Feedback Laser) light source, a transmitter driver circuit and a signal conditioner circuit on the TX data inputs. (see Figure 1) Optical connection to the transmitter is provided via a LC connector. The optical output is controlled by a custom IC that detects the laser output via the monitor photodiode. This IC provides both DC and AC current drive to the laser to ensure correct modulation, eye diagram and extinction ratio over temperature, supply voltage and operating life.

TX_DIS

Asserting pin 5, TX_DIS, will disable the transmitter optical output. The transmitter output can also be disabled and monitored via the two-wire serial interface.

Eye Safety Circuit

Under normal operating conditions laser power will be maintained below Class 1 eye-safety limits.

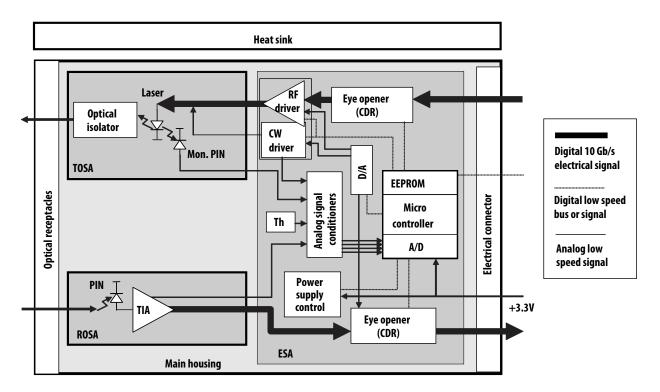


Figure 1. Transceiver Functional Diagram

Receiver Section

The receiver section includes a PIN detector with amplification quantization signal conditioner circuits. (see Figure 1) Optical connection to the receiver is provided via a LC optical connector.

RX_LOS

The receiver section contains a loss of signal (RX_LOS) circuit to indicate when the optical input signal power is insufficient for reliable signal detection. A high signal indicates loss of modulated signal, indicating link failure such as a broken fiber or nonfunctional remote transmitter. RX_LOS can also be monitored via the two-wire serial interface (byte 110, bit 1).

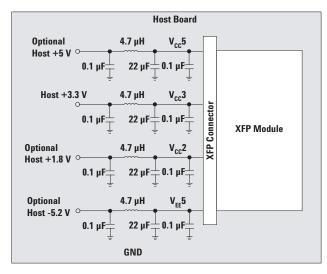


Figure 2. MSA recommended power supply filter

Functional Data I/O

Avago Technologies' AFCT-721XPDZ fiber-optic transceiver is designed to accept industry standard electrical input differential signals. The transceiver provides AC-coupled, internally terminated data input and output interfaces. Bias resistors and coupling capacitors have been included within the module to reduce the number of components required on the customer's board.

Electrical Pinout

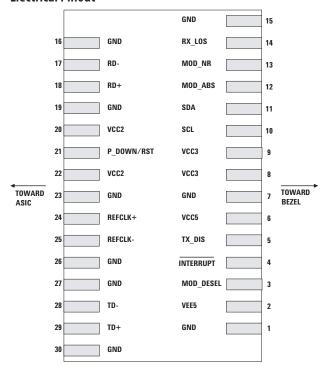


Figure 3. Host PCB XFP Pinout Top View

Table 1. Electrical Pin Definitions

| Pin | Name | Logic | Function/Description | Notes |
|-----|-------------------|-----------|---|-------|
| 1 | GND | | Module Ground | 1 |
| 2 | V _{EE} 5 | | -5.2 V power supply. (Not Used) | |
| 3 | Mod-Desel | LVTTL-I | Module De-select; When held low allows the module to respond to 2-wire Serial interface commands | |
| 4 | Interrupt | LVTTL-O | Interrupt; Indicates presence of an important condition which can be readover the serial 2-wire interface | 2 |
| 5 | TX_DIS | LVTTL-I | Transmitter Disable; Transmitter Laser Source Turned Off | 4 |
| 6 | V _{CC} 5 | | 5 V power supply. (Not Used) | |
| 7 | GND | | Module Ground | 1 |
| 8 | V _{CC} 3 | | +3.3 V Power Supply | |
| 9 | V _{CC} 3 | | +3.3 V Power Supply | |
| 10 | SCL | LVTTL-I | Two Wire Interface Clock | 2 |
| 11 | SDA | LVTTL-I/O | Two Wire Interface Data Line | 2 |
| 12 | Mod_Abs | LVTTL-O | LVTTL-O Mod_Abs Indicates Module is not present. Grounded in the Module | 2 |
| 13 | Mod_NR | LVTTL-O | Module Not Ready; Indicating Module Operational Fault | 2 |
| 14 | RX_LOS | LVTTL-O | Receiver Loss Of Signal Indicator | 2 |
| 15 | GND | | Module Ground | 1 |
| 16 | GND | | Module Ground | 1 |
| 17 | RD- | CML-O | Receiver Inverted Data Output | |
| 18 | RD+ | CML-O | Receiver Non-Inverted Data Output | |
| 19 | GND | | Module Ground | 1 |
| 20 | V _{CC} 2 | | +1.8 V Power Supply. (Not Used) | |
| 21 | P_Down/RST | LVTTL-I | Power down: When high, the module is put into a lower power mode. Serial interface is functional in the low power mode. Reset: The falling edge initiates a complete reset of the module including the serial Interface, equivalent to a power cycle. | 4 |
| 22 | V _{CC} 2 | | +1.8 V Power Supply. (Not Used) | |
| 23 | GND | | Module Ground | 1 |
| 24 | RefCLK+ | PECL-I | Reference Clock Non-Inverted Input, AC coupled on the host board (Not Used) | 3 |
| 25 | RefCLK- | PECL-I | Reference Clock Inverted Input, AC coupled on the host board (Not Used) | 3 |
| 26 | GND | | Module Ground | 1 |
| 27 | GND | | Module Ground | 1 |
| 28 | TD- | CML-I | Transmitter Inverted Data Input | |
| 29 | TD+ | CML-I | Transmitter Non-Inverted Data Input | |
| 30 | GND | <u> </u> | Module Ground | 1 |

Notes:

- 1. Module ground pins Gnd are isolated from the module case and chassis ground within the module.
- 2. Open Collector should be pulled up with 4.7K Ω τ o 10K Ω to a voltage between 3.15 V and 3.6 V on the host board.
- 3. RefCLK+/- are internally terminated (50 Ω)
- 4. Pulled up to Vcc3 via 4.7-10K Ω resistor inside the module

Absolute Maximum Ratings

| Parameter | Symbol | Minimum | Typical | Maximum | Unit | Notes |
|-------------------------------------|-------------------|---------|---------|----------------------|------|---------|
| Storage Temperature (non-operating) | T _S | -40 | · | +85 | °C | 1, 2, 3 |
| Ambient Operating Temperature | T _A | -40 | | +85 | °C | 1, 2, 3 |
| Relative Humidity | RH | 10 | | 90 | % | 1 |
| Supply Voltage | V _{CC} 3 | 0 | | 3.6 | V | 1, 2 |
| Low Speed Input Voltage | V _{IN} | -0.5 | | V _{CC} +0.5 | V | 1 |

Recommended Operating Conditions [4]

| Parameter | Symbol | Minimum | Typical | Maximum | Unit | Notes |
|----------------------------|-------------------|---------|---------|---------|------|-------|
| Case Operating Temperature | T _C | -5 | | +70 | °C | 3 |
| Supply Voltage | V _{CC} 3 | 3.135 | ' | 3.465 | V | 5 |
| Data Rate | | 9.95 | | 11.3 | Gb/s | |

Transceiver Electrical Characteristics

 $(T_C = -5 \text{ °C to } +70 \text{ °C}, \ V_{CC}3 = 3.3 \text{ V} \pm 5\%)$

| Parameter | Symbol | Minimum | Typical | Maximum | Unit | Notes |
|---|------------------------------------|----------------------------------|---------|----------------------------------|--------|--------|
| Power Supply Noise Rejection (peak-peak) under 1MHz | PSNR | | ' | 2% of V _{CC} | mV | 6 |
| Power Supply Noise Rejection (peak-peak) 1MHz to 10 MHz | PSNR | | ' | 3% of V _{CC} | mV | 6 |
| Module supply current | lcc | | 425 | 605 | mA | |
| Power Dissipation | P _{DISS} | | 1410 | 2100 | mW | |
| Low Speed Outputs: MOD_NR, RX_LOS, MOD_ABS, INTERRUPT | V _{OH} V _{OL} | Host_V _{CC} -0.5 0.0 | | Host_V _{CC} +0.3 0.4 | V V | 7 8 |
| Low Speed Inputs: TX_DIS, MOD_DESEL, | V _{IH} | 2.0 | | V _{CC} 3+0.3 | V | 10 |
| P_DOWN/RST | V_{IL} | -0.5 | | 0.8 | V | 9 |

Notes

- 1. Absolute Maximum Ratings are those values beyond which damage to the device may occur if these limits are exceeded for other than a short period of time. See Reliability Data Sheet for specific reliability performance.
- 2. Between Absolute Maximum Ratings and the Recommended Operating Conditions functional performance is not intended, device reliability is not implied, and damage to the device may occur over an extended period of time.
- 3. The Ambient Operating Temperature limitations are based on the Case Operating Temperature limitations and are subject to the host system thermal design.
- 4. Recommended Operating Conditions are those values for which functional performance and device reliability is implied
- 5. Vcc condition applies to supply voltage at the XFP module
- 6. Power Supply filtering on host board required as per XFP MSA specification.
- 7. $4.7 \text{ K}\Omega$ to 10 K Ω resistor pull-up to host_V_{CC}, measured at the host side of connector. I_{OH}(max) = -2 mA.
- 8. 4.7 K Ω to 10 K Ω resistor pull-up to host_V_{CC}, measured at the host side of connector. I_{OL} (max) = 2 mA.
- 9. $4.7~\text{K}\Omega$ to $10~\text{K}\Omega$ resistor pull-up to host_V_{CC}, measured at the host side of connector. $I_{\text{IL}}(\text{max}) = 10~\mu\text{A}$.
- 10. 4.7 K Ω to 10 K Ω resistor pull-up to host_V_{CC}, measured at the host side of connector. $I_{IH}(max) = -10 \ \mu A$.

Transmitter Electrical Input Characteristics

 $(T_C = -5 \, ^{\circ}C \text{ to } +70 \, ^{\circ}C, V_{CC}3 = 3.3 \, V \pm 5\%)$

| Parameter | Symbol | Minimum | Typical | Maximum | Unit | Notes |
|--|----------------|---------------------------------------|---------|---------|------|-------------------|
| Differential Input Impedance | Z _d | | 100 | | Ω | |
| Termination Mismatch | ΔZ_{M} | | | 5 | % | |
| Differential Input Amplitude | ΔVQDO | 120 | | 820 | mV | peak to peak (1) |
| Differential Input Return Loss | SDD11 | 20 | | | dB | 0.05 to 0.1 GHz |
| Differential Input Return Loss | SDD11 | 8 | | | dB | 0.1 to 5.5 GHz |
| Differential Input Return Loss | SDD11 | 8 - 20.66 log10(f/5.5) f in GHz | | | dB | 5.5 - 12 GHz |
| Common Mode Input Return Loss | SCC11 | 3 | | | dB | 0.1 to 12 GHz |
| Differential to Common Mode Conversion | SCD11 | 10 | | | dB | 0.1 to 12 GHz |
| Jitter and Eye Mask | | | | | | XFP MSA Compliant |

Receiver Electrical Output Characteristics

| Parameter | Symbol | Minimum | Typical | Maximum | Unit | Notes |
|---------------------------------------|---------------------------------|---------------------------------------|---------|---------|------|-------------------|
| Differential Input Impedance | Z _d | | 100 | | Ω | |
| Termination Mismatch | ΔZ_{M} | | | 5 | % | |
| Differential Output Amplitude | ΔVQDO | 340 | | 850 | mV | peak to peak (1) |
| DC Common Mode Potential | V _{cm} | 0 | | 3.6 | V | |
| Output AC Common Mode Voltage | , | | | 15 | mV | RMS |
| Output Rise/Fall time (20% to 80%) | t _r , t _f | 24 | | | ps | |
| Common mode output return loss | SCC22 | 3 | | | dB | 0.1 to 12 GHz |
| Differential output return loss | SDD22 | 20 | | | dB | 0.05 to 0.1 GHz |
| Differential output return loss | SDD22 | 8 | | | dB | 0.1 to 5.5 GHz |
| Differential output return loss | SDD22 | 8 - 20.66 log10(f/5.5) f in GHz |) | | dB | 5.5 - 12 GHz |
| Jitter and Eye Mask | | | | | | XFP MSA Compliant |

Note:

^{1.} The differential input and output amplitudes are per XFP MSA Rev 4.5 mask at points B' and C'.

Transmitter Optical Characteristics 10 GbE/10GFC

 $(T_C = -5 \degree C \text{ to } +70 \degree C, \ V_{CC} 3 = 3.3 \ V \pm 5\%)$

| Parameter | Symbol | Minimum | Typical | Maximum | Unit | Notes |
|---|------------------|---------|---------|---------|---------|-------|
| Optical Output Power | P _{out} | -5.2 | | | dBm OMA | 1, 2 |
| Average Optical Output Power | P _{out} | -8.2 | | 0.5 | dBm | 1, 2 |
| Extinction Ratio | ER | 3.5 | | ' | dB | 1, 2 |
| Spectral Width - rms | σ, rms | | | 0.2 | nm RMS | 3 |
| Center Wavelength | λC | 1260 | 1310 | 1355 | nm | |
| Transmitter and dispersion penalty | TDP | | | 3.2 | dB | 1, 2 |
| Side mode suppression ratio | | 30 | | | dB | 1 |
| Optical output power (min) in OMA -TDP | | -6.2 | | | dBm OMA | 1, 2 |
| RIN ₁₂ (OMA) | RIN | | | -128 | dB/Hz | 1 |
| Optical Eye Mask Compliant with IEEE 802.3ae 10GBASE-LR | | | | | | |

Receiver Optical Characteristics 10 GbE/10GFC

 $(T_C = -5 \text{ °C to } +70 \text{ °C}, \ V_{CC}3 = 3.3 \text{ V} \pm 5\%)$

| Parameter | Symbol | Minimum | Typical | Maximum | Unit | Notes |
|-------------------------------|-----------------|---------|---------|---------|----------|-------|
| Average Receive power | | -14.4 | | 0.5 | dBm mean | 1 |
| Stressed receiver sensitivity | · | ' | | -10.3 | dBm OMA | 1 |
| Receiver sensitivity | P _{IN} | ' | | -12.6 | dBm OMA | 3 |
| Max Receiver Reflectance | | | | -12 | dB | 1 |
| Wavelength | λC | 1260 | 1310 | 1355 | nm | |

Notes:

- 1. 10GFC 1200-SM-LL-L / IEEE 802.3ae 10BASE-LR compliant
- 2. These parameters are interrelated: see IEEE 802.3ae
- 3. For information only

Transceiver Timing Characteristics

 $(T_C = -5 \, ^{\circ}C \text{ to } +70 \, ^{\circ}C, V_{CC}3 = 3.3 \, V \pm 5\%)$

| Parameter | Symbol | Minimum | Typical | Maximum | Unit | Notes |
|-----------------------------|--------------------|---------|---------|---------|------|--|
| TX_DIS Assert Time | t_off | | | 20 | μs | Time from rising edge of TX_DIS to when the optical output falls below 10% of nominal. |
| TX_DIS Negate Time | t_on | | | 2 | ms | Time from falling edge of TX_DIS to when the modulated optical output rises above 90% of nominal. |
| Time to initialize | t_init | | | 300 | ms | From power on or hot plug after meeting power supply specs |
| Interrupt assert delay | Interrupt_on | | | 200 | ms | From occurrence of the condition triggering interrupt |
| Interrupt negate delay | Interrupt_off | | | 500 | us | From clear on read interrupt flags |
| P_Down/ RST assert delay | P_Down/RST_on | | | 100 | us | From Power down initiation |
| P-Down negate delay | P_Down/RST_ off | | | 300 | ms | Max delay from negate to completion of power up and reset |
| Mod_NR assert delay | Mod_nr_on | | | 1 | ms | From Occurrence of fault to assertion of MOD_NR |
| Mod_NR negate delay | Mod_nr_off | | | 1 | ms | From Occurrence of signal to negation of MOD_NR |
| Mod_DeSel assert time | T_Mod_DeSel | | | 2 | ms | Maximum delay between assertion of Mod_DeSel and end of module response to 2-wire interface communications |
| Mod_DeSel de-assert time | T_Mod_Sel | | | 2 | ms | Maximum delay between de-asser- tion of Mod_DeSel and proper mod- ule response to 2-wire interface communications |
| P_Down reset time | t_reset | 10 | | | μs | Min length of P-Down assert to initial reset |
| RX_LOS Assert delay | T_loss_on | | | 100 | μs | From Occurrence of loss of signal to assertion of RX_LOS |
| RX_LOS negate delay | T_loss_off | 2.3 | | 100 | μs | From Occurrence of presence of signal to negation of RX_LOS |
| Serial ID Clock Rate | f_serial_clock | 0 | | 400 | kHz | |

Digital Diagnostic Interface and Serial Identification

The 2-wire serial interface is explicitly defined in the XFP MSA Rev 4.0. 2-wire timing specifications and the structure of the memory map are per XFP MSA Rev 2.0. The normal 256 Byte I2C address space is divided into lower and upper blocks of 128 Bytes. The lower block of 128 Bytes is always directly available and is used for diagnostic information providing the opportunity for Predictive Failure Identification, Compliance Prediction, Fault Isolation and Component Monitoring. The upper address space tables are used for less frequently accessed functions such as serial ID, user writeable EE-PROM, reserved EEPROM and diagnostics and control spaces for future standards definition, as well as Avago Technologies-specific functions.

Predictive Failure Identification

The diagnostic information allows the host system to identify potential link problems. Once identified, a "fail over" technique can be used to isolate and replace suspect devices before system uptime is impacted.

Compliance Prediction

The real-time diagnostic parameters can be monitored to alert the system when operating limits are exceeded and compliance cannot be ensured. As an example, the real time average receive optical power can be used to assess the compliance of the cable plant and remote transmitter.

Fault Isolation

The diagnostic information can allow the host to pinpoint the location of a link problem and accelerate system servicing and minimize downtime.

Component Monitoring

As part of host system qualification and verification, real time transceiver diagnostic information can be combined with system level monitoring to ensure performance and operating environment are meeting application requirements.

Transceiver Module Temperature

The transceiver module temperature represents the module case temperature. It is a calibrated value from an internal PCB temperature measured using a sensing circuitry.

Transmitter Laser DC Bias Current

Laser bias current is measured using sensing circuitry located on the transmitter laser driver IC. Normal variations in laser bias current are expected to accommodate the impact of changing transceiver temperature and supply voltage operating points. The AFCT-721XPDZ uses a closed loop laser bias feedback circuit to maintain constant optical power over time at a given temperature. This circuit compensates for normal laser parametric variations in quantum efficiency, forward voltage and lasing threshold due to changing transceiver operating points.

Transmitted Average Optical Output Power

Variations in average optical power are not expected under normal operation because the AFCT-721XPDZ uses a closed loop laser bias feedback circuit to maintain constant optical power. This circuit compensates for normal laser parametric variations due to changing transceiver operating points. Only under extreme laser bias conditions will significant drifting in transmitted average optical power be observable. Therefore it is recommended Tx average optical power be used for fault isolation, rather than predictive failure purposes.

Received Average Optical Input Power

Received average optical power measurements are a valuable asset for installers to verify cable plant compliance. Drifts in average power can be observed from the cable plant and remote transmitter for potential predictive failure use. Received average optical power can be used for fault isolation.

Auxiliary Monitors

There are two auxiliary monitors implemented in the AFCT-721XPDZ. One is the +3.3V supply voltage reported as Auxiliary Measurement 2. The other is the Module PCB Temperature reported as Auxiliary Measurement 1. As there is no auxiliary type defined for Module PCB Temperature, the auxiliary type for Laser Temperature (0100b) is used in this case.

Mechanical Specifications

Package Dimensions

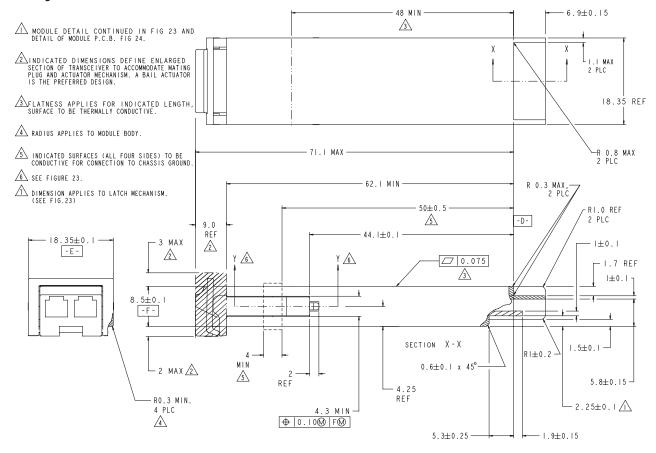
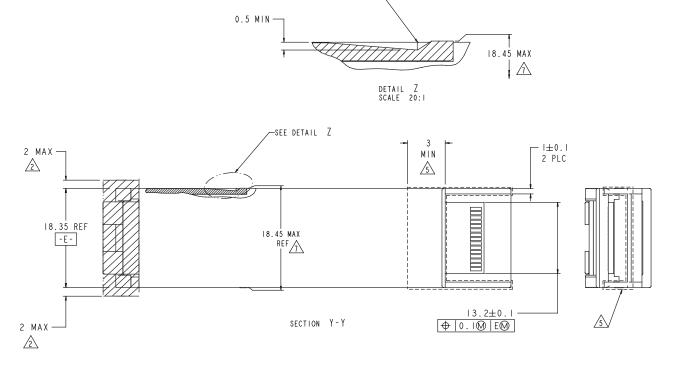


Figure 4a. Module Drawing



R .05 MIN

Figure 4b. Module Drawing

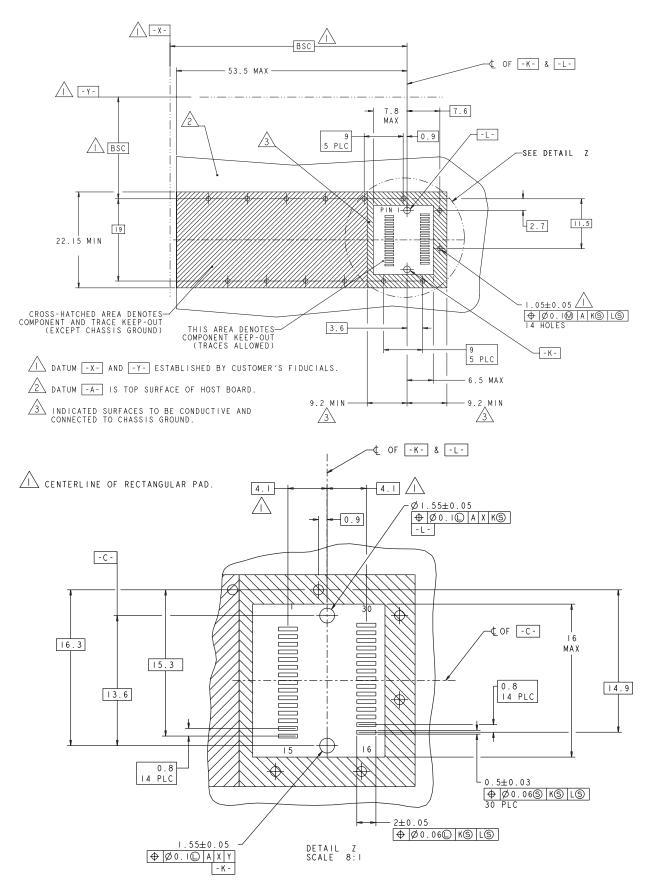


Figure 5. XFP host board mechanical layout

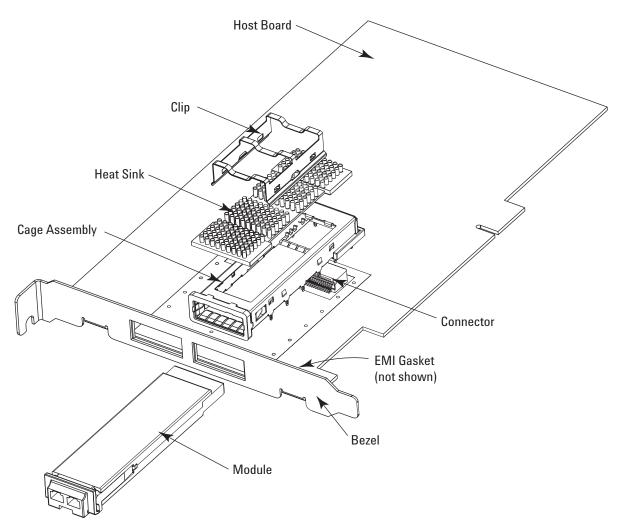


Figure 6. XFP Assembly Drawing

Application Support

An Evaluation Kit and Reference Designs are available to assist in evaluation of the AFCT-721XPDZ. Please contact your local Field Sales representative for availability and ordering details.

Regulatory Compliance

The transceiver Regulatory Compliance performance is provided in Table 2 as a figure of merit to assist the designer. The overall equipment design will determine the certification level.

Electrostatic Discharge (ESD)

There are two conditions in which immunity to ESD damage is important. Table 2 documents the ESD immunity to both of these conditions.

The first condition is static discharge to the transceiver during handling such as when the transceiver is inserted into the transceiver port. To protect the transceiver, it is important to use normal ESD handling precautions including the use of grounded wrist straps, work benches, and floor mats in ESD controlled areas. The ESD sensitivity of the AFCT-721XPDZ is compatible with typical industry production environments.

The second condition is static discharge to the exterior of the host equipment chassis after installation. To the extent that the duplex LC optical interface is exposed to the outside of the host equipment chassis, it may be subject to system-level ESD requirements.

The ESD performance of the AFCT-721XPDZ exceeds typical industry standards.

Table 2. Regulatory Compliance

| Feature | Test Method | Performance |
|---|---|--|
| Electrostatic Discharge (ESD) to the exterior of the XFP module | JEDEC JESD22-A114-B | 500 Volts to the high speed pins, 2000 Volts to the low speed pins |
| Electrostatic Discharge (ESD) to the Duplex LC Receptacle | Variation of IEC 61000-4-2 | Typically, no damage occurs with 25 kV when the duplex LC connector receptacle is contacted by a Human Body Model probe. |
| Electrostatic Discharge (ESD) to the Optical Connector | GR1089 | 10 contacts of 8 KV on the electrical faceplate with device inserted into a panel. |
| Electrostatic Discharge (ESD) to the Optical Connector | Variation of IEC 801-2 | Air discharge of 15 kV(min) contact to connector w/o damage |
| Electromagnetic Interference (EMI) | FCC Class B CENELEC EN55022 Class B (CISPR 22A) VCCI Class 1 | System margins are dependent on customer board and chassis design. |
| Immunity | Variation of IEC 61000-4-3 | Less than 0.5 dB of Rx sensitivity degradation and less than 10% margin re- duction of Tx mask at 10 V/m, 10 MHZ to 1 GHz w/o chassis enclosure |
| Laser Eye Safety and Equipment Type Testing | US FDA CDRH AEL Class 1 US21 CFR, Subchapter J per Paragraphs 1002.10 and 1002.12. (IEC) EN60825-1: 1994 + A11+A2 (IEC) EN60825-2: 1994 + A1 (IEC) EN60950: 1992 + A1 + A2 + A3 + A4 + A11 | CDRH accession # 951220 TUV certificate # R72071466 |
| Component Recognition | Underwriters Laboratories and Canadian Standards Association Joint Component Recognition for Information Technology Equipment Including Electrical Business Equipment | UL file # E173874 |

Immunity

The transceivers have a shielded design to provide excellent immunity to radio-frequency electromagnetic fields which may be present in some operating environments.

Electromagnetic Interference (EMI)

Most equipment designs using the AFCT-721XPDZ are subject to the requirements of the FCC in the United States, CENELEC EN55022 (CISPR 22) in Europe and VCCI in Japan. The metal housing and shielded design of the AFCT-721XPDZ minimizes EMI and provides excellent EMI performance.

Eye Safety

The AFCT-721XPDZ transceivers provide Class 1 eye safety by design. Avago Technologies has tested the transceiver design for regulatory compliance, under normal operating conditions and under single fault conditions. See Table 2.

Flammability

The AFCT-721XPDZ is compliant to UL 94V-0.

Caution

The AFCT-721XPDZ contains no user serviceable parts. Tampering with or modifying the performance of the AFCT-721XPDZ will result in voided product warranty. It may also result in improper operation of the AFCT-721XPDZ circuitry, and possible overstress of the laser source. Device degradation or product failure may result. Connection of the AFCT-721XPDZ to a non-approved optical source, operating above the recommended absolute maximum conditions may be considered an act of modifying or manufacturing a laser product. The person(s) performing such an act is required by law to recertify and reidentify the laser product under the provisions of U.S. 21 CFR (Subchapter J) and the TUV.

Ordering Information

Please contact your local field sales engineer or one of Avago Technologies franchised distributors for ordering information. For technical information, please visit Avago Technologies' WEB page at www.avagotech.com or contact Avago Technologies Semiconductor Products Customer Response Center at 1-800-235-0312. For information related to XFP MSA documentation visit www.xfpmsa.org

